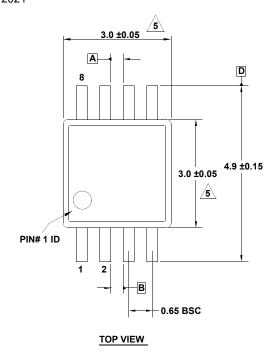
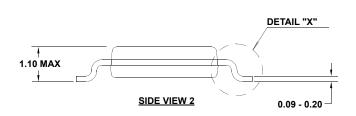
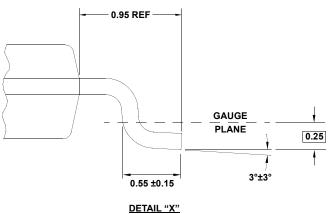
## **Plastic Packages for Integrated Circuits**

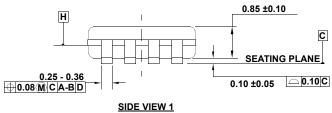
## **Package Outline Drawing**

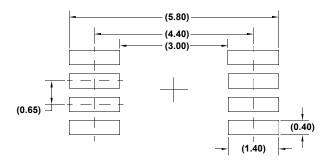
M8.118 8 Lead Mini Small Outline Plastic Package Rev 5, 5/2021











TYPICAL RECOMMENDED LAND PATTERN

## NOTES:

- 1. Dimensions are in millimeters.
- Dimensioning and tolerancing conform to JEDEC MO-187-AA and AMSEY14.5m-1994.
- Plastic or metal protrusions of 0.15mm max per side are not included.
- 4. Plastic interlead protrusions of 0.15mm max per side are not included.
- 5. Dimensions are measured at Datum Plane "H".
- 6. Dimensions in ( ) are for reference only.

